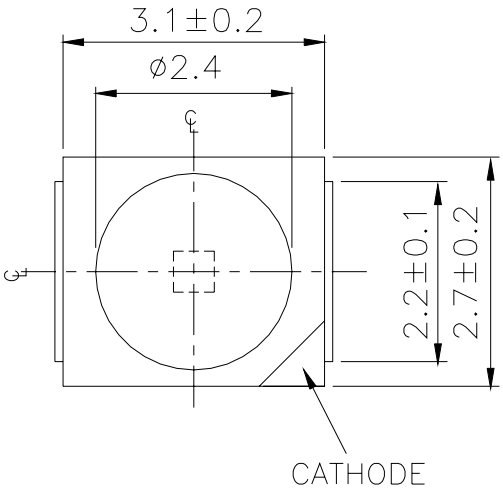
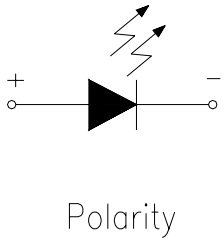
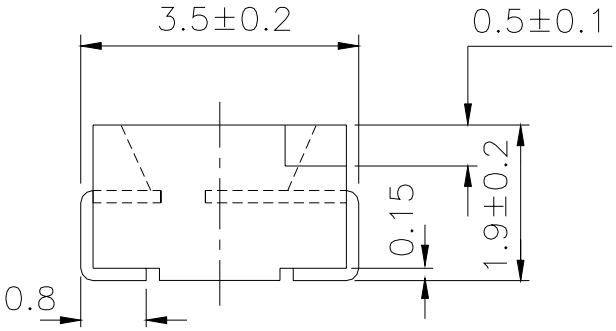
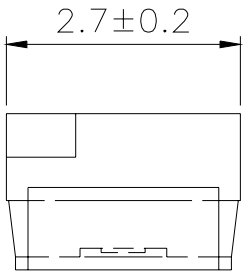
67-21UYOC/S530-XX/R8

Package Dimensions

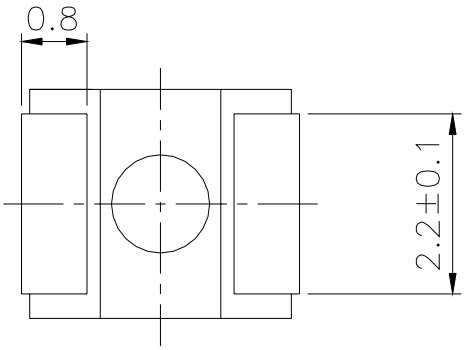


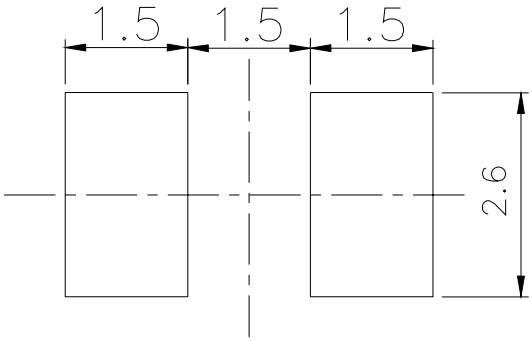






For reflow soldering (Proposal)





Note: The tolerances unless mentioned is ±0.1mm ;Unit = mm

67-21UYC/S530-XX/TR8

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_F	25	mA
Operating Temperature	Topr	-40 ~ +85	℃
Storage Temperature	Tstg	-40~ +100	℃
Soldering Temperature	Tsol	260 (for 5 second)	℃
Electrostatic Discharge	ESD	2000	V
Power Dissipation	Pd	60	mW
Peak Forward Current(Duty 1/10 @ 1KHz)	I_{FP}	60	mA

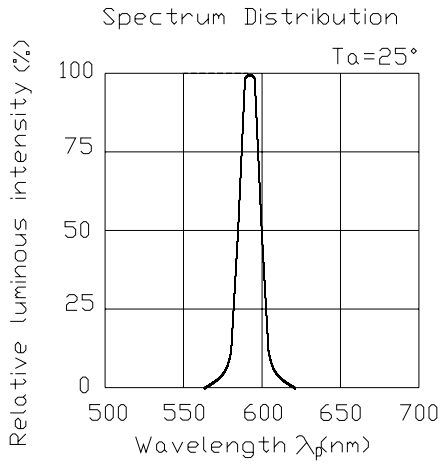
Electro-Optical Characteristics (Ta=25℃)

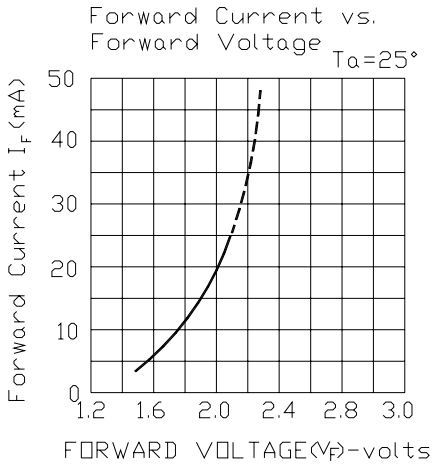
Parameter	Symbol	*Chip Rank	Min.	Typ.	Max.	Unit	Condition
Luminous intensity	Iv	A2	40	55	-----	mcd	IF=20mA
		A3	50	85	-----		
		A4	63	106	-----		
		A5	80	133	-----		
		A6	100	177	-----		
		A7	125	215	-----		
Viewing Angle	2θ 1/2	-----	-----	120	-----	deg	IF=20mA
Peak Wavelength	λ p	-----	-----	591	-----	nm	IF=20mA
Dominant Wavelength	λ d	-----	-----	589	-----	nm	IF=20mA
Spectrum Radiation Bandwidth	△λ	-----	-----	15	-----	nm	IF=20mA
Forward Voltage	VF	-----	-----	2.0	2.4	V	IF=20mA
Reverse Current	IR	-----	-----	-----	10	μA	VR=5V

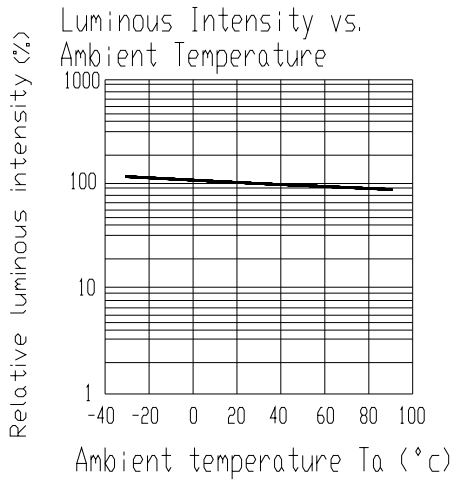
*67-21UYC/S530-XX/TR8

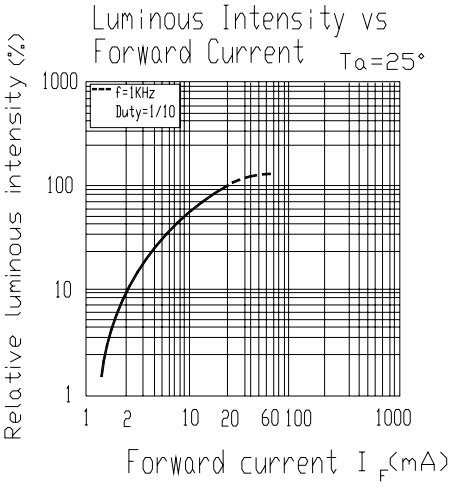
Chip Rank

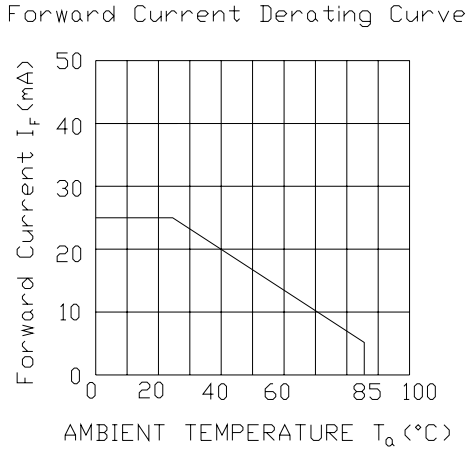
Typical Electro-Optical Characteristics Curves

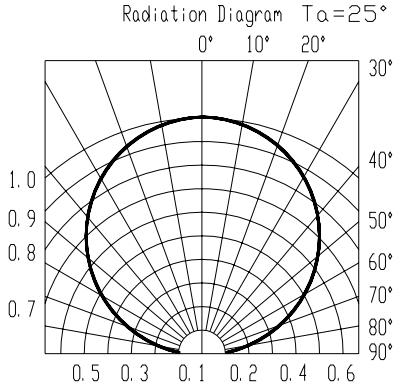












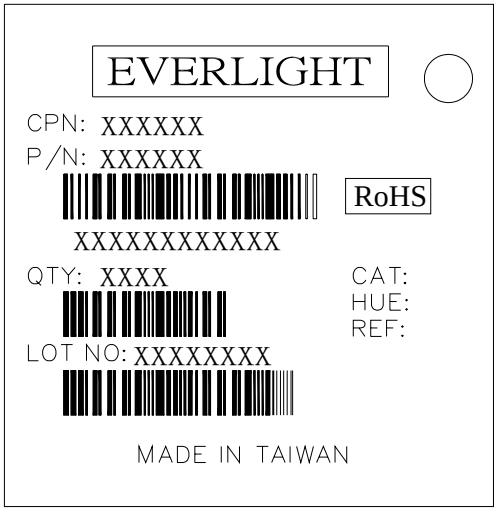
67-21UYC/S530-XX/TR8

Label explanation

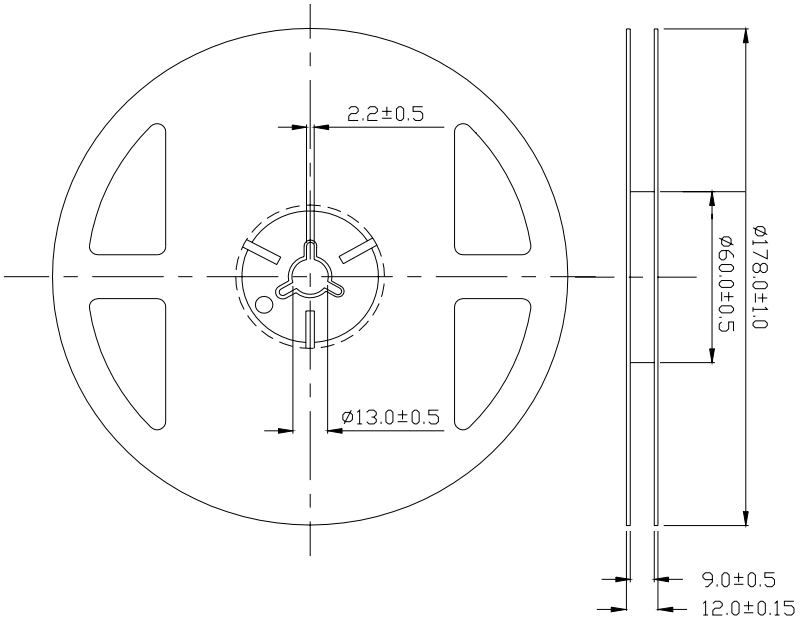
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



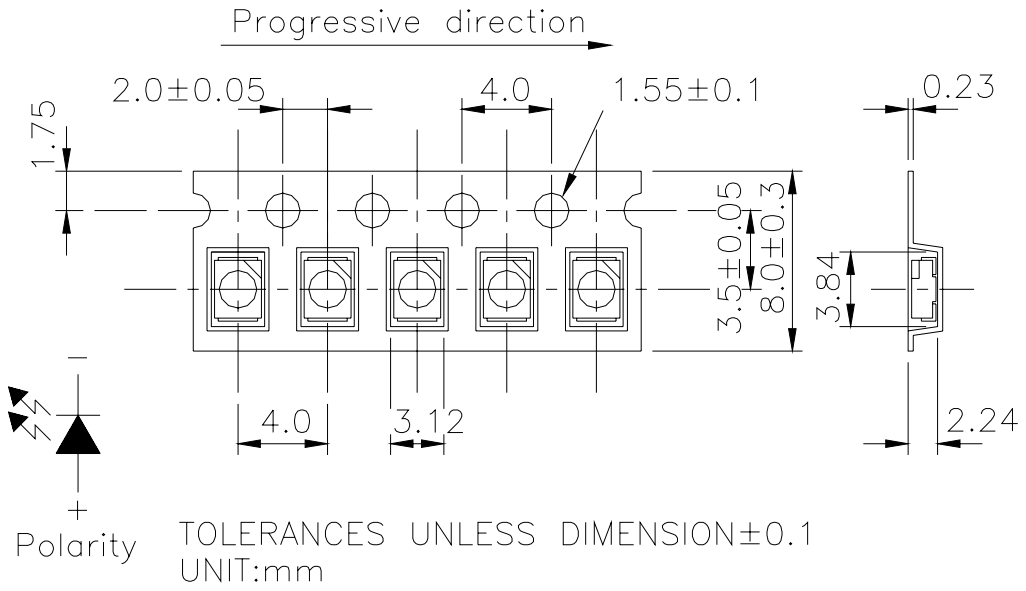
Reel Dimensions



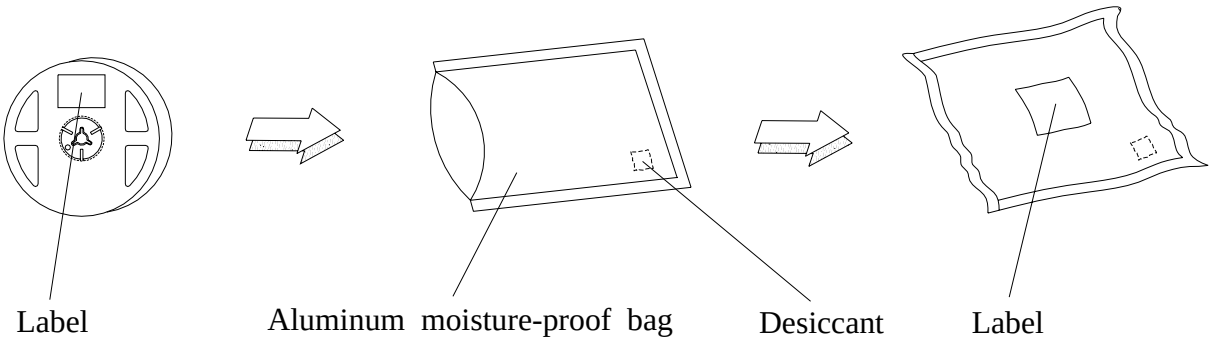
Note: The tolerances unless mentioned is ±0.1mm ,Unit = mm

67-21UYC/S530-XX/TR8

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel.



Moisture Resistant Packaging



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level：90%

LTPD：10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260℃±5℃ Min. 5sec.	6 min	22 PCS.	0/1
2	Temperature Cycle	H : +100℃ 15min ∫ 5 min L : -40℃ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100℃ 5min ∫ 10 sec L : -10℃ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	I_F = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/ 85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30℃ or less and 90%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30℃ or less and 70%RH or less.

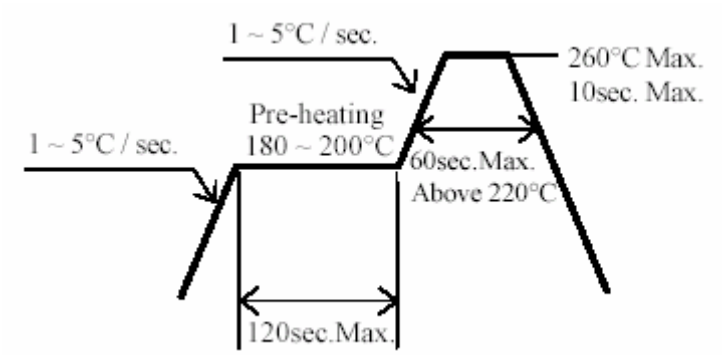
2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5℃ for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

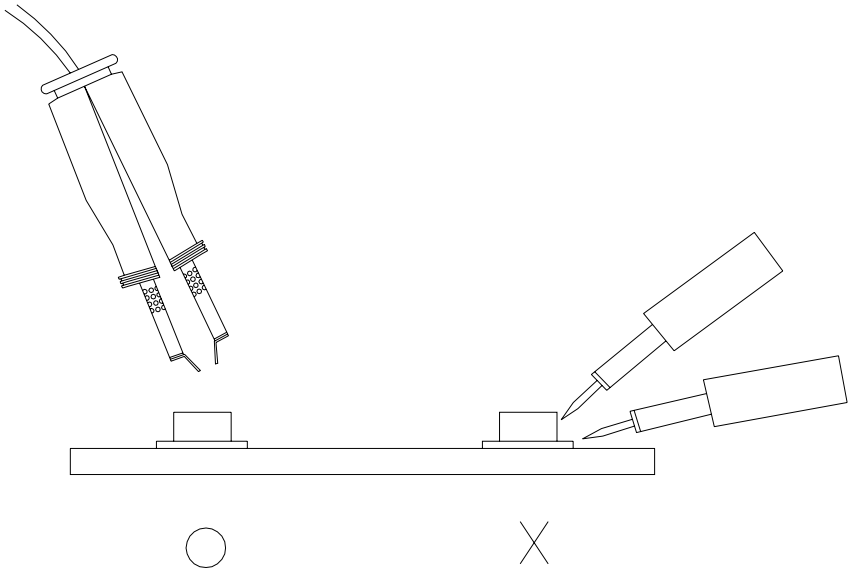
3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280℃ for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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